

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0700S4T-5

This module uses ROHS material

For Customer's Acceptance:

	-
Customer	
Approved	
Comment	

This specification may change without prior notice in
order to improve performance or quality. Please contact
Multi-Inno for updated specification and product status
before design for this product or release of this order.

Revision	1.1
Engineering	
Date	2013-08-28
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2013-07-18	First release	
1.1	2013-08-28	Update Timing	



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■ GENERAL INFORMATION

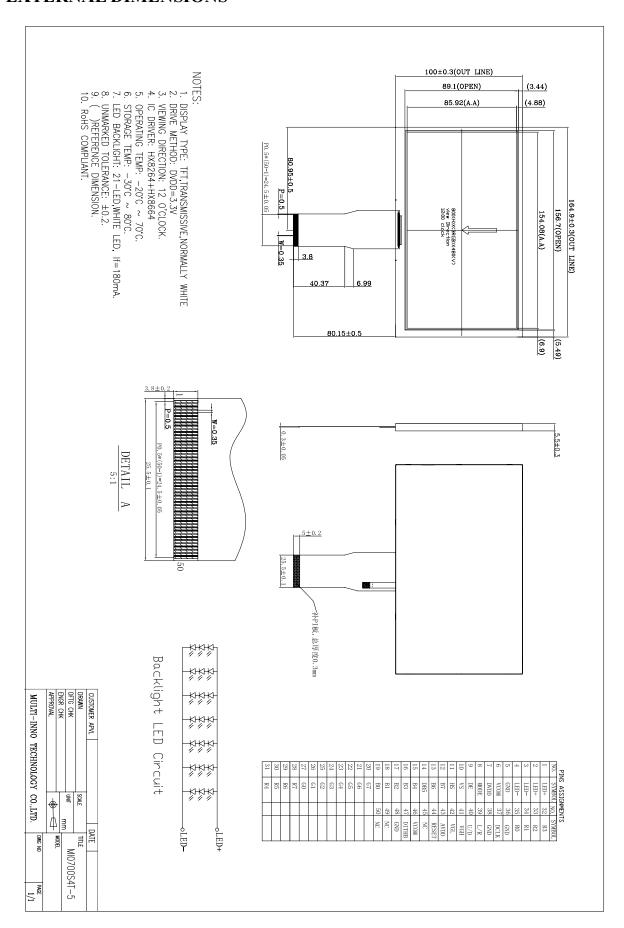
Item	Contents	Unit
LCD type	TFT/Transmissve/Normally white	/
Size	7.0	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
LCM (W×H)×D	164.90×100.00×5.50	mm ³
Active area (W×H)	154.08×85.92	mm ²
Pixel size (W×H)	0.0642×0.1790	mm ²
Number of dots	800 (RGB) × 480	/
Driver IC	HX8264+HX8664	/
Backlight type	21 LEDs	/
Interface type	24bit RGB	/
Color depth	16.7M	/
Surface treatment	Anti-glare Anti-glare	/
Color arrangement	RGB-stripe	/
Backlight power consumption	1.728	W
Panel power consumption	327	mW
Input voltage	3.3	V
With/Without TSP	Without TSP	/
Weight	150	g

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift. Note 2: RoHS compliant;

Note 3: LCM weight tolerance: ± 5%.



■ EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
	DVDD	-0.3	5.0	V
Down voltage	AVDD	6.5	13.5	V
Power voltage	VGH	-0.3	43.0	V
	VGL	-20.0	0.3	V
	VGH-VGL	12	40.0	V
LED reverse voltage	V_R	-	1.2	V
LED forward current	I _F	-	30	mA
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 2: VR Conditions: Zener Diode 20mA

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

L	G11		I Imit	D		
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
	DVDD	3.0	3.3	3.6	V	Note 2
Dominio analysis a	AVDD	9.4	9.6	9.8	V	
Power voltage	VGH	17.0	18.0	19.0	V	
	VGL	-6.6	-6.0	-5.4	V	
Input signal voltage	VCOM	3.8	4.0	4.2	V	
Input logic high voltage	VIH	0.7 DV _{DD}	-	DV _{DD}	V	Nata 2
Input logic low voltage	VIL	0	-	0.3 DV _{DD}	V	Note 3

Note 1: Be sure to apply DV_{DD} and V_{GL} to the LCD first, and then apply V_{GH}.

Note 2: DV_{DD} setting should match the signals output voltage (refer to Note 3) of customer's system board.

Note 3: DCLK,HS,VS,RESET,U/D, L/R,DE,R0~R7,G0~G7,B0~B7,MODE,DITHB.



CURRENT CONSUMPTION

	Complete 1	Values			TT.: 14	D 1	
Item	Symbol	Min.	Тур.	Max.	Unit	Remark	
	I _{GH}	-	0.5	1	mA	V _{GH} =18.0V	
Comment for Driver	I _{GL}	-	0.5	1	mA	$V_{GL} = -6.0V$	
Current for Driver	IDV _{DD}	-	8	15	mA	DV _{DD} =3.3V	
	IAV _{DD}	-	30	40	mA	AV _{DD} =9.6V	

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Values			Unit	Remark
item	Symbol	Min.	Тур.	Max.	Onit	Remark
Voltage for LED backlight	V _L	(9.3)	(9.9)	(10.5)	V	Note 1
Current for LED backlight	IL	(170)	(180)	(200)	mA	
LED life time	-	20,000	-	-	Hr	Note 2

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 $^{\circ}$ C and I_L =180mA. The LED lifetime could be decreased if operating I_L is lager than 180mA.



ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time	Tr +Tf		-	25	50	ms	Fig.1	4
Contrastratio	Cr	θ=0°	400	500	-		FIG 2.	1
Luminance uniformity	δ WHITE	Ø=0° Ta=25℃	70	75	-	%	FIG 2.	3
Surface Luminance	Lv	1 a-23 C	320	400	-	cd/m ²	FIG 2.	2
		Ø = 90°	40	50	-	deg	FIG 3.	
Viewing angle range	θ	Ø = 270°	60	70	-	deg	FIG 3.	6
viewing angle range		$\emptyset = 0$ °	60	70	-	deg	FIG 3.] "
		Ø = 180°	60	70	-	deg	FIG 3.	
	Red x		TBD	TBD	TBD			
	Red y		TBD	TBD	TBD			
	Green x	θ=0°	TBD	TBD	TBD			
CIE (x, y) chromaticity	Green y	Ø=0° Ta=25°C	TBD	TBD	TBD		FIG 2.	5
	Blue x		TBD	TBD	TBD]	110 2.	
	Blue y		TBD	TBD	TBD]		
	White x		0.260	0.310	0.360			
	White y		0.280	0.330	0.380			

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = Average Surface Luminance with all white pixels (P₁,P₂, P₃,P₄, P₅)

Average Surface Luminance with all black pixels (P₁, P₂, P₃,P₄, P₅)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x,y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



FIG.1. The definition of Response Time

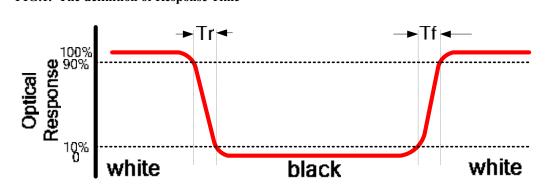


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A:5 mm

B:5 mm

H,V: Active Area

Light spot size ∅=5mm, 500mm distance from the

LCD surface to detector lens

measurement instrument is TOPCON's luminance

meter BM-5

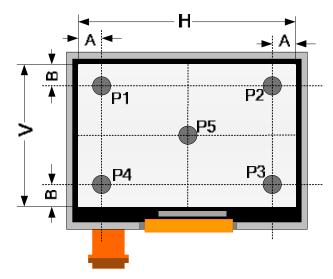
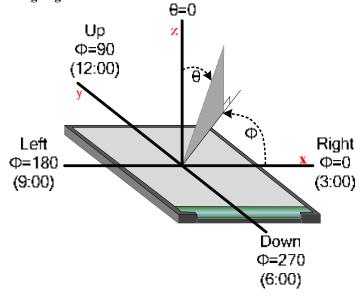


FIG.3. The definition of viewing angle





■ INTERFACE DESCRIPTION

FPC Connector is used for the module electronics interface. The recommended model is FH12A-50S-0.5SH manufactured by Hirose.

Pin No. Symbol I/O Functi Remark P 1 $V_{LED^{+}}$ Power for LED backlight (Anode) 2 $V_{LED^{+}}$ P Power for LED backlight (Anode) 3 VLED-P Power for LED backlight (Cathode) 4 V_{LED}-P Power for LED backlight (Cathode) 5 **GND** P Power ground Common voltage 6 V_{COM} I 7 DV_{DD} P Power for Digital Circuit 8 **MODE** I DE/SYNC mode select Note 1 9 DE I Data Input Enable VS 10 Ι Vertical Sync Input 11 HS I Horizontal Sync Input 12 B7 I Blue data(MSB) 13 **B6** I Blue data 14 B5 Ι Blue data 15 **B4** I Blue data 16 В3 Ι Blue data 17 B2 Ι Blue data 18 B1 I Blue data Note 2 19 **B**0 I Blue data(LSB) Note 2 Green data(MSB) 20 G7 I

Note 2

Note 2

G6

G5

G4

G3

G2

G1

G0

I

I

Ι

I

I

I

I

Green data

Green data

Green data

Green data

Green data

Green data

Green data(LSB)

21

22

23

24

25

26

27



	ı		
R7	I	Red data(MSB)	
R6	I	Red data	
R5	I	Red data	
R4	I	Red data	
R3	I	Red data	
R2	I	Red data	
R1	I	Red data	Note 2
R0	I	Red data(LSB)	Note 2
GND	P	Power Ground	
DCLK	I	Sample clock	Note 3
GND	P	Power Ground	
L/R	I	Left / right selection	Note 4,5
U/D	I	Up/down selection	Note 4,5
VGH	P	Gate ON Voltage	
VGL	P	Gate OFF Voltage	
AV_{DD}	P	Power for Analog Circuit	
RESET	I	Global reset pin.	Note 6
NC	-	No connection	
V_{COM}	I	Common Voltage	
DITHB	I	Dithering function	Note 7
GND	P	Power Ground	
NC	-	No connection	
NC	-	No connection	
	R6 R5 R4 R3 R2 R1 R0 GND DCLK GND L/R U/D VGH VGL AVDD RESET NC VCOM DITHB GND NC	R6 I R5 I R4 I R3 I R2 I R1 I R0 I GND P DCLK I GND P L/R I U/D I VGH P VGL P RESET I NC - VCOM I DITHB I GND P NC -	R6 I Red data R5 I Red data R4 I Red data R3 I Red data R2 I Red data R1 I Red data R0 I Red data R0 I Red data(LSB) GND P Power Ground DCLK I Sample clock GND P Power Ground L/R I Left / right selection U/D I Up/down selection VGH P Gate ON Voltage VGL P Gate OFF Voltage AVDD P Power for Analog Circuit RESET I Global reset pin. NC - No connection VCOM I Common Voltage DITHB I Dithering function GND P Power Ground NC - No connection

I: input, O: output, P: Power

Note 1: DE/SYNC mode select. Normally pull high.

When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE= "0", DE must be grounded.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

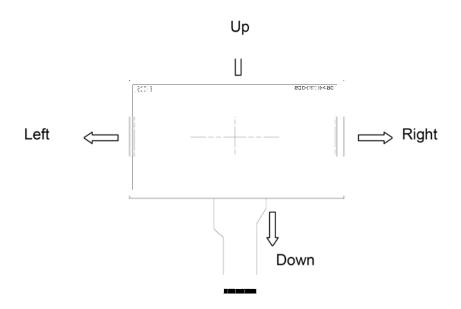
Note 4: Selection of scanning mode.

Set of scan contr	ol input	Scanning direction
U/D	L/R	
GND	DV _{DD}	Up to down, left to right
DV _{DD}	GND	Down to up, right to left
GND	GND	Up to down, right to left
DVDD	DVDD	Down to up, left to right



Note 5: Definition of scanning direction.

Refer to the figure as below:



Note 6: Global reset pin. Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 7: Dithering function enable control, normally pull high. When DITHB="1",Disable internal dithering function, When DITHB="0",Enable internal dithering function.



■ APPLICATION NOTES

1. Timing Characteristics

1.1 AC Electrical Characteristics

	G 1 1		Values		**	D 1
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thh	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvh	8	-	-	ns	
Data setup time	Tds	8	-	-	ns	
Data hole time	Tdh	8	-	-	ns	
DE setup time	Tes	8	-	-	ns	
DE hole time	Teh	8	-	-	ns	
DVDD Power On Slew rate	TPOR	-	-	20	ms	From 0 to 90% DVDD
RESET pulse width	TRst	1	-	-	ms	
DCLK cycle time	Тсо	20	-	-	ns	
DCLK pulse duty	Tewh	40	50	60	%	



1.2. Data Input Format

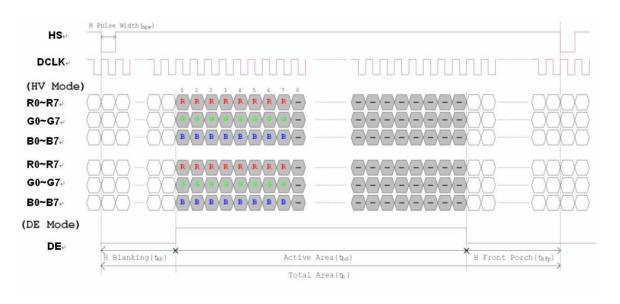


Figure 1 Horizon input timing diagram

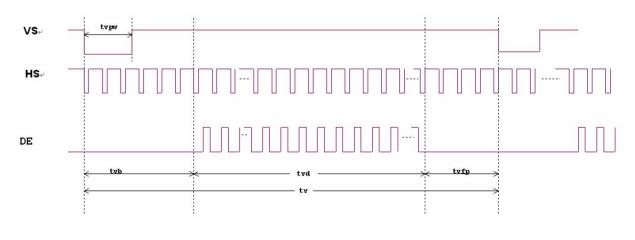


Figure 2 Vertical input timing diagram



1.3. Timing

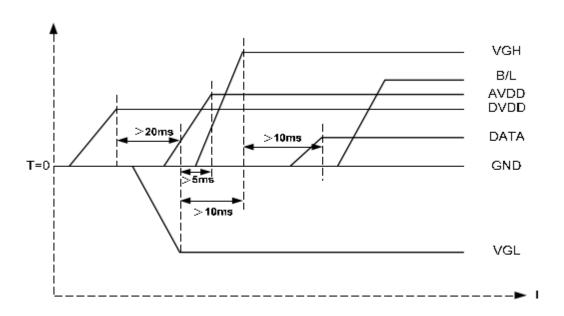
	Courselle of	Values			T I.a.i4	D 1
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk	29.0	33.0	38.0	MHz	
One Horizontal Line	th	1026	1056	1086	DCLK	
HS pulse width	thpw	-	30	-	DCLK	
HS Blanking	thb	-	46	-	DCLK	
HS Front Porch	thfp	180	210	240	DCLK	

T.	G11		Values			D 1
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	515	525	535	TH	
VS pulse width	tvpw	-	13	-	TH	
VS Blanking	tvb	-	23	-	TH	
VS Front Porch	tvfp	12	22	32	TH	



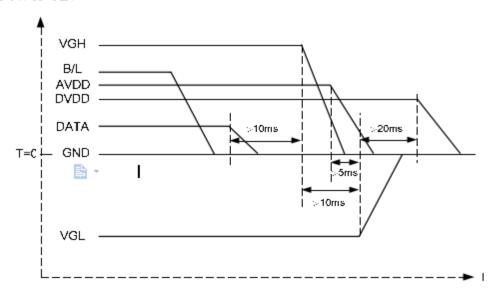
2. Power Sequence

a. Power on:



 $DV_{DD} \rightarrow VGL \rightarrow VGH \rightarrow Data \rightarrow B/L$

b. Power off:



$$B/L \rightarrow Data \rightarrow VGH \rightarrow VGL \rightarrow DV_{DD}$$

Note: Data include R0~R7, B0~B7, GO~G7, U/D, L/R, DCLK, HS, VS, DE.



■ RELIABILITY TEST

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	80±2°C/240 hours	NOTE1,NOTE4
2	Low Temperature Storage	-30±2°C/240 hours	NOTE1,NOTE4
3	High Temperature Operating	70±2°C/240 hours	NOTE2,NOTE4
4	Low Temperature Operating	-20±2°C/240 hours	NOTE2,NOTE4
5	Temperature Cycle storage	$-30\pm2^{\circ}\text{C} \sim 25 \sim 80\pm2^{\circ}\text{C} \times 20 \text{ cycles}$ (30min.) (5min.) (30min.)	NOTE4
6	Damp proof Test operating	60 °C ± 5 °C × 90%RH/240 hours	NOTE4
7	Vibration Test	Frequency: 10~55Hz Stroke:1.5mm Sweep: 10Hz~55Hz~10Hz 2hours for each direction of X.Y.Z (6 hours for total)	
8	Package vibration test	Random vibration :0.15G*G/HZ from 5-200HZ,-6dB/Octave from 200-500HZ of each direction of X.Y. Z (6 hours for total)	
9	Package drop test	Height:60 cm 1 corner,3 edges,6 surfaces	
10	ESD test	±2KV, Human body mode,100pF	
11	Mechanical shock	100G 6ms,±X, ±Y,±Z 3 times for each direction	

- Note 1: Ta is the ambient temperature of samples.
- Note 2: Ts is the temperature of panel's surface.
- Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.
- Note 4: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.



■ INSPECTION CRITERION

MIF	OUTGOING QUALITY STANDARD	PAGE 1 OF 4
TITLE:FUNCTIO	NAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch panel.

1 Sample plan

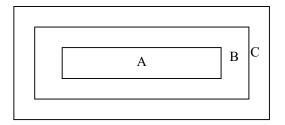
Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



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TITLE:FUNCT	TIONAL TEST & INSPECTION CRITERIA	MDS Product

4. Inspection standards

4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	

4.2 Cosmetic Defect

Item No	Items to be inspected		Inspection St	andard		Classification of defects	
	Clear Spots Black and	For dark/white spot, s as $\Phi = \frac{(x+y)}{2}$					
	white Spot	Zone	F	Acceptable (Qty		
	defect Pinhole,	Size(mm)	A	В	С	Minor	
	Foreign Particle,	Ф≤0.10	Ign	ore			
	Dirt under polarizer	0.10<Φ≤0.15	2		Ignore		
		0.15<Φ≤0.20	1		- Ignore		
4.2.1		Φ>0.20	0				
	Dim Spots	2.					
	Circle	2. Zone	Acc	ceptable Qty			
	shaped and dim edged	Size(mm)	A	В	С		
	defects	Ф≤0.2	Ignore	2		Minor	
		0.20<Φ≤0.40	3		Ignore	Willion	
		0.40<Φ≤0.60	2		ignore		
		0.60<Φ≤0.80	1				
		0.80<Φ	0				



OUTGOING QUALITY STANDARD
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TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

MDS Product

4.2. Cosmetic Defect

Item No	Items to be inspected		Inspection St	andard			Classification of defects
		Siz	ze(mm)	Acc	eptable (Qty	
Line defect Black line, White line, Foreign	L(Length)	W(Width)	A	Zone B	С		
	Ignore	W≤0.02	Igno	ore		2.6	
4.2.2	material	L≤3.0	0.02 <w≤0.03< td=""><td>2</td><td></td><td></td><td>Minor</td></w≤0.03<>	2			Minor
	under polarizer,	L≤2.0	0.03 < W < 0.05	1		Ignore	
			0.05 <w< td=""><td>Define a</td><td></td><td></td><td></td></w<>	Define a			
Polorizar	If the Polarizer scratch can be se condition or some special angle, ju		judge by the following. Acceptable Qty				
4.2.3	Polarizer scratch	L(Length)	I (I anoth) W(W: M)		Zone	Minor	
	L(Length)	L(Length)	W(Width)	A E	3	С	
		Ignore	W≤0.03	Ignore			
		5.0 <l≤10.0< td=""><td>0.03 < W < 0.05</td><td>2</td><td>Io</td><td>nore</td><td></td></l≤10.0<>	0.03 < W < 0.05	2	Io	nore	
		L≤5.0	0.05 < W < 0.08	1			
			0.08 <w< td=""><td>0</td><td></td><td></td><td></td></w<>	0			
		Air bubbles bet	ween glass & polar	rizer			
		2. Zone	Ac	ceptable Q	ty		
	Polarize	Size(mm)	A	В	C	1	
4.2.4	Air bubble	Ф≤0.2	Ignore	gnore			Minor
		0.20<Φ≤0.30	2	Ignore		ore	
		0.30<Φ≤0.50	1		Isin		
		0.50<Φ	0				



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TITLE:FUNCTI	ONAL TEST & INSPECTION CRITERIA	MDS Product

4.3. Cosmetic Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
		(i) Chips on corner	Minor
		X Y Z	
		\leq 2.0 \leq S Disregard	
		Notes: S=contact pad length Chips on the corner of terminal shall not be allowed to extend into the ITO pad or expose perimeter seal.	
4.3.5 Glass defect		X Y Z	Minor
		≤3.0 <inner border="" disregard<="" line="" of="" seal="" td="" the=""><td></td></inner>	
		(iii) Crack Cracks tend to break are not allowed.	Major
4.3.6	Parts alignment	 Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. Not allow chip or solder component is off center more than 50% of the pad outline. 	Minor
4.3.7	SMT	According to the <acceptability assemblies="" electronic="" of=""> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability>	

■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

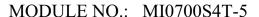
- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling





and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

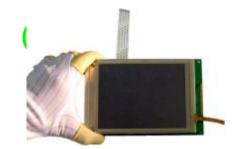
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.



2 Handling precaution for LCM

- 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
- 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others 其它

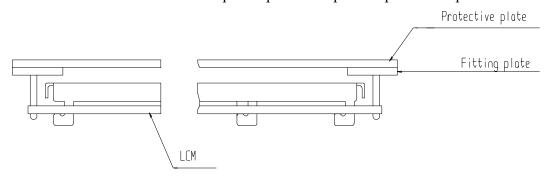
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

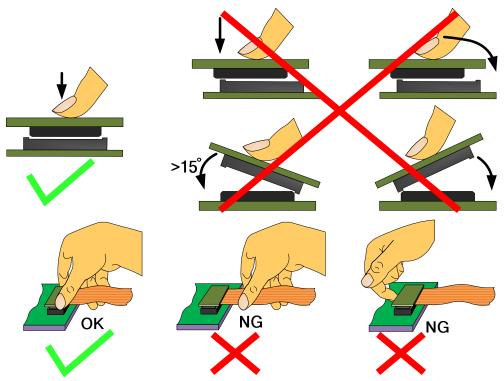


4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
Product	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
Floduct			Press: 0.8~1.2Mpa
RoHS	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
Product	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
rioduct			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.